

Welcome to [E-XFL.COM](http://E-XFL.COM)

### Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

### Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

Product Status	Obsolete
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	400MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (2)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	-
Package / Case	516-BBGA
Supplier Device Package	516-PBGA (27x27)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8247vrtiea">https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8247vrtiea</a>

# 1 Overview

This table shows the functionality supported by each SoC in the MPC8272 family.

**Table 1. MPC8272 PowerQUICC II Family Functionality**

Functionality	Package <sup>1</sup>	SoCs			
		MPC8272	MPC8248	MPC8271	MPC8247
<b>516 PBGA</b>					
Serial communications controllers (SCCs)	3	3	3	3	3
QUICC multi-channel controller (QMC)	Yes	Yes	Yes	Yes	Yes
Fast communication controllers (FCCs)	2	2	2	2	2
I-Cache (Kbyte)	16	16	16	16	16
D-Cache (Kbyte)	16	16	16	16	16
Ethernet (10/100)	2	2	2	2	2
UTOPIA II Ports	1	0	1	0	0
Multi-channel controllers (MCCs)	0	0	0	0	0
PCI bridge	Yes	Yes	Yes	Yes	Yes
Transmission convergence (TC) layer	—	—	—	—	—
Inverse multiplexing for ATM (IMA)	—	—	—	—	—
Universal serial bus (USB) 2.0 full/low rate	1	1	1	1	1
Security engine (SEC)	Yes	Yes	—	—	—

<sup>1</sup> See [Table 2](#).

Devices in the MPC8272 family are available in two packages—the VR or ZQ package—as shown in . For package ordering information, see [Section 10, “Ordering Information.”](#)

**Table 2. MPC8272 PowerQUICC II Device Packages**

Code (Package)	VR (516 PBGA—Lead free)	ZQ (516 PBGA—Lead spheres)
Device	MPC8272VR	MPC8272ZQ
	MPC8248VR	MPC8248ZQ
	MPC8271VR	MPC8271ZQ
	MPC8247VR	MPC8247ZQ

**Table 5. DC Electrical Characteristics<sup>1</sup> (continued)**

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 6.0\text{mA}$ <u>BR</u> <u>BG/IRQ6</u> <u>ABB/IRQ2</u> <u>TS</u> <u>A[0-31]</u> <u>TT[0-4]</u> <u>TBST</u> <u>TSIZE[0-3]</u> <u>AACK</u> <u>ARTRY</u> <u>DBG/IRQ7</u> <u>DBB/IRQ3</u> <u>D[0-63]</u> <u>IRQ3/CKSTP_OUT/EXT_BR3</u> <u>IRQ4/CORE_SRESET/EXT_BG3</u> <u>IRQ5/TBEN/EXT_DBG3/CINT</u> <u>PSDVAL</u> <u>TA</u> <u>TEA</u> <u>GBL/IRQ1</u> <u>CI/BADDR29/IRQ2</u> <u>WT/BADDR30/IRQ3</u> <u>BADDR31/IRQ5/CINT</u> <u>CPU_BR/INT_OUT</u> <u>IRQ0/NMI_OUT</u> <u>PORESET/PCI_RST</u> <u>HRESET</u> <u>SRESET</u> <u>RSTCONF</u>	$V_{OL}$	—	0.4	V

**Table 5. DC Electrical Characteristics<sup>1</sup> (continued)**

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 5.3\text{mA}$ <u>CS[0-5]</u> <u>CS6/BCTL1/SMI</u> <u>CS7/TLBSYNC</u> <u>BADDR27/ IRQ1</u> <u>BADDR28/ IRQ2</u> <u>ALE/ IRQ4</u> <u>BCTL0</u> <u>PWE[0-7]/PSDDQM[0-7]/PBS[0-7]</u> <u>PSDA10/PGPL0</u> <u>PSDWE/PGPL1</u> <u>POE/PSDRAS/PGPL2</u> <u>PSDCAS/PGPL3</u> <u>PGTA/PUPMWAIT/PGPL4</u> <u>PSDAMUX/PGPL5</u> <u>PCI_CFG0 (PCI_HOST_EN)</u> <u>PCI_CFG1 (PCI_ARB_EN)</u> <u>PCI_CFG2 (DLL_ENABLE)</u> <u>MODCK1/RSRV/TC(0)/BNKSEL(0)</u> <u>MODCK2/CSE0/TC(1)/BNKSEL(1)</u> <u>MODCK3CSE1/TC(2)/BNKSEL(2)</u> $I_{OL} = 3.2\text{mA}$ <u>PCI_PAR</u> <u>PCI_FRAME</u> <u>PCI_TRDY</u> <u>PCI_IRDY</u> <u>PCI_STOP</u> <u>PCI_DEVSEL</u> <u>PCI_IDSEL</u> <u>PCI_PERR</u> <u>PCI_SERR</u> <u>PCI_REQ0</u> <u>PCI_REQ1/ CPI_HS_ES</u> <u>PCI_GNT0</u> <u>PCI_GNT1/ CPI_HS_LES</u> <u>PCI_GNT2/ CPI_HS_ENUM</u> <u>PCI_RST</u> <u>PCI_INTA</u> <u>PCI_REQ2</u> <u>DLLOUT</u> <u>PCI_AD(0-31)</u> <u>PCI_C(0-3)/BE(0-3)</u> <u>PA[8-31]</u> <u>PB[18-31]</u> <u>PC[0-1,4-29]</u> <u>PD[7-25, 29-31]</u> <u>TDO</u>	$V_{OL}$	—	0.4	V

<sup>1</sup> The default configuration of the CPM pins (PA[8-31], PB[18-31], PC[0-1,4-29], PD[7-25, 29-31]) is input. To prevent excessive DC current, it is recommended either to pull unused pins to GND or VDDH, or to configure them as outputs.

<sup>2</sup> TCK, TRST and PORESET have min VIH = 2.5V.

<sup>3</sup>  $V_{IL}$  for IIC interface does not match IIC standard, but does meet IIC standard for  $V_{OL}$  and should not cause any compatibility issue.

<sup>4</sup> The leakage current is measured for nominal VDDH, VCCSYN, and VDD.

## DC Electrical Characteristics

<sup>5</sup> MPC8272 and MPC8271 only.

Table 6.

Characteristic	Symbol	Min	Max	Unit
Input high voltage—all inputs except TCK, TRST and PORESET <sup>1</sup>	V <sub>IH</sub>	2.0	3.465	V
Input low voltage	V <sub>IL</sub>	GND	0.8	V
CLKIN input high voltage	V <sub>IHC</sub>	2.4	3.465	V
CLKIN input low voltage	V <sub>ILC</sub>	GND	0.4	V
Input leakage current, V <sub>IN</sub> = VDDH <sup>2</sup>	I <sub>IN</sub>	—	10	µA
Hi-Z (off state) leakage current, V <sub>IN</sub> = VDDH <sup>2</sup>	I <sub>OZ</sub>	—	10	µA
Signal low input current, V <sub>IL</sub> = 0.8 V <sup>3</sup>	I <sub>L</sub>	—	1	µA
Signal high input current, V <sub>IH</sub> = 2.0 V	I <sub>H</sub>	—	1	µA
Output high voltage, I <sub>OH</sub> = -2 mA except UTOPIA mode, and open drain pins	V <sub>OH</sub>	2.4	—	V
In UTOPIA mode <sup>4</sup> (UTOPIA pins only): I <sub>OH</sub> = -8.0mA				
In UTOPIA mode <sup>4</sup> (UTOPIA pins only): I <sub>OL</sub> = 8.0mA	V <sub>OL</sub>	—	0.5	V
I <sub>OL</sub> = 6.0mA BR BG ABB/IRQ2 TS A[0-31] TT[0-4] TBST TSIZE[0-3] AACK ARTRY DBG DBB/IRQ3 D[0-63] //EXT_BR3 //EXT_BG3 /TBEN/EXT_DBG3/CINT PSDVAL TA TEA GBL/IRQ1 CI/BADDR29/IRQ2 WT/BADDR30/IRQ3 BADDR31/IRQ5/CINT CPU_BR IRQ0/NMI_OUT /PCI_RST HRESET SRESET RSTCONF	V <sub>OL</sub>	—	0.4	V

Table 6.

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 5.3\text{mA}$ <u>CS[0-9]</u> <u>CS(10)/BCTL1</u> <u>CS(11)/AP(0)</u> <u>BADDR[27-28]</u> <u>ALE</u> <u>BCTL0</u> <u>PWE[0-7]/PSDDQM[0-7]/PBS[0-7]</u> <u>PSDA10/PGPL0</u> <u>PSDWE/PGPL1</u> <u>POE/PSDRAS/PGPL2</u> <u>PSDCAS/PGPL3</u> <u>PGTA/PUPMWAIT/PGPL4/PPBS</u> <u>PSDAMUX/PGPL5</u> <u>LWE[0-3]/LSDDQM[0-3]/LBS[0-3]/PCI_CFG[0-3]</u> <u>LSDA10/LGPL0/PCI_MODCKH0</u> <u>LSDWE/LGPL1/PCI_MODCKH1</u> <u>LOE/LSDRAS/LGPL2/PCI_MODCKH2</u> <u>LSDCAS/LGPL3/PCI_MODCKH3</u> <u>LGTA/LUPMWAIT/LGPL4/LPBS</u> <u>LSDAMUX/LGPL5/PCI_MODCK</u> <u>LWR</u> <u>MODCK[1-3]/AP[1-3]/TC[0-2]/BNKSEL[0-2]</u> $I_{OL} = 3.2\text{mA}$ <u>L_A14/PAR</u> <u>L_A15/FRAME/SMI</u> <u>L_A16/TRDY</u> <u>L_A17/IRDY/CKSTP_OUT</u> <u>L_A18/STOP</u> <u>L_A19/DEVSEL</u> <u>L_A20/IDSEL</u> <u>L_A21/PERR</u> <u>L_A22/SERR</u> <u>L_A23/REQ0</u> <u>L_A24/REQ1/HSEJSW</u> <u>L_A25/GNT0</u> <u>L_A26/GNT1/HSLED</u> <u>L_A27/GNT2/HSENUM</u> <u>L_A28/RST/CORE_SRESET</u> <u>L_A29/INTAL_A30/REQ2</u> <u>L_A31</u> <u>LCL_D[0-31])/AD[0-31]</u> <u>LCL_DP[03]/C/BE[0-3]</u> <u>PA[0-31]</u> <u>PB[4-31]</u> <u>PC[0-31]</u> <u>PD[4-31]</u> <u>TDO</u> <u>QREQ</u>	$V_{OL}$	—	0.4	V

<sup>1</sup> TCK, TRST and PORESET have min VIH = 2.5V.<sup>2</sup> The leakage current is measured for nominal VDDH, VCCSYN, and VDD.<sup>3</sup>  $V_{IL}$  for IIC interface does not match IIC standard, but does meet IIC standard for  $V_{OL}$  and should not cause any compatibility issue.

## Thermal Characteristics

<sup>4</sup> MPC8280, MPC8275VR, MPC8275ZQ only.

## 4 Thermal Characteristics

This table describes thermal characteristics. See [Table 2](#) for information on a given SoC's package. Discussions of each characteristic are provided in [Section 4.1, “Estimation with Junction-to-Ambient Thermal Resistance,”](#) through [Section 4.7, “References.”](#) For the these discussions,  $P_D = (V_{DD} \times I_{DD}) + PI/O$ , where PI/O is the power dissipation of the I/O drivers.

**Table 7. Thermal Characteristics**

Characteristic	Symbol	Value	Unit	Air Flow
Junction-to-ambient—single-layer board <sup>1</sup>	$R_{\theta JA}$	27	°C/W	Natural convection
		21		1 m/s
Junction-to-ambient—four-layer board	$R_{\theta JA}$	19	°C/W	Natural convection
		16		1 m/s
Junction-to-board <sup>2</sup>	$R_{\theta JB}$	11	°C/W	—
Junction-to-case <sup>3</sup>	$R_{\theta JC}$	8	°C/W	—
Junction-to-package top <sup>4</sup>	$R_{\theta JT}$	2	°C/W	—

<sup>1</sup> Assumes no thermal vias

<sup>2</sup> Thermal resistance between the die and the printed circuit board per JEDEC JESD51-8. Board temperature is measured on the top surface of the board near the package.

<sup>3</sup> Thermal resistance between the die and the case top surface as measured by the cold plate method (MIL SPEC-883 Method 1012.1).

<sup>4</sup> Thermal characterization parameter indicating the temperature difference between package top and the junction temperature per JEDEC JESD51-2. When Greek letters are not available, the thermal characterization parameter is written as Psi-JT.

### 4.1 Estimation with Junction-to-Ambient Thermal Resistance

An estimation of the chip junction temperature,  $T_J$ , in °C can be obtained from the following equation:

$$T_J = T_A + (R_{\theta JA} \times P_D)$$

where:

$T_A$  = ambient temperature (°C)

$R_{\theta JA}$  = package junction-to-ambient thermal resistance (°C/W)

$P_D$  = power dissipation in package

The junction-to-ambient thermal resistance is an industry standard value that provides a quick and easy estimation of thermal performance. However, the answer is only an estimate; test cases have demonstrated that errors of a factor of two (in the quantity  $T_J - T_A$ ) are possible.

This table lists CPM input characteristics.

**NOTE: Rise/Fall Time on CPM Input Pins**

It is recommended that the rise/fall time on CPM input pins should not exceed 5 ns. This should be enforced especially on clock signals. Rise time refers to signal transitions from 10% to 90% of VCC; fall time refers to transitions from 90% to 10% of VCC.

**Table 11. AC Characteristics for CPM Inputs<sup>1</sup>**

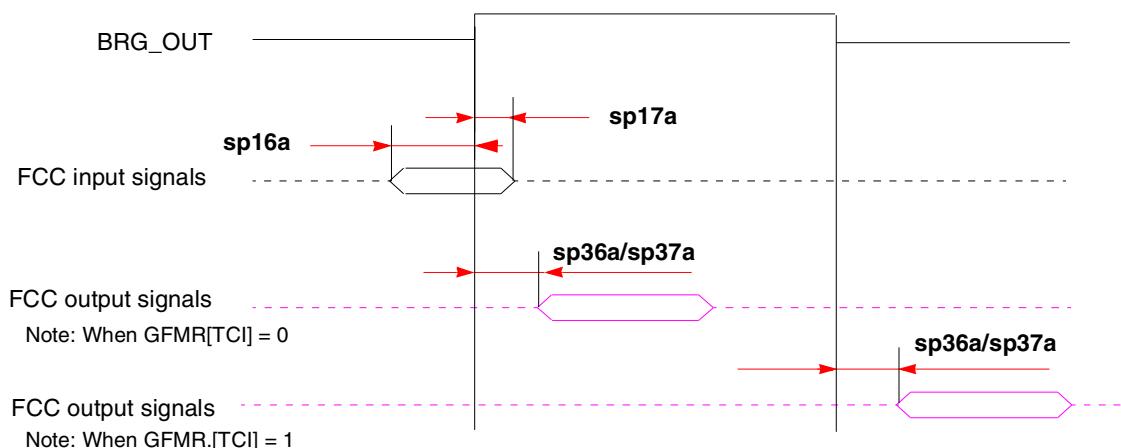
<b>Spec Number</b>		<b>Characteristic</b>	<b>Value (ns)</b>							
			<b>Setup</b>				<b>Hold</b>			
<b>Setup</b>	<b>Hold</b>		<b>66 MHz</b>	<b>83 MHz</b>	<b>100 MHz</b>	<b>133 MHz</b>	<b>66 MHz</b>	<b>83 MHz</b>	<b>100 MHz</b>	<b>133 MHz</b>
sp16a	sp17a	FCC inputs—internal clock (NMSI)	6	6	6	6	0	0	0	0
sp16b	sp17b	FCC inputs—external clock (NMSI)	2.5	2.5	2.5	2.5	2	2	2	2
sp18a	sp19a	SCC/SMC/SPI/I2C inputs—internal clock (NMSI)	6	6	6	6	0	0	0	0
sp18b	sp19b	SCC/SMC/SPI/I2C inputs—external clock (NMSI)	4	4	4	4	2	2	2	2
sp20	sp21	TDM inputs/SI	3	3	3	3	2.5	2.5	2.5	2.5
sp22	sp23	PIO/TIMER/IDMA inputs	8	8	8	8	0.5	0.5	0.5	0.5

<sup>1</sup> Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

**NOTE**

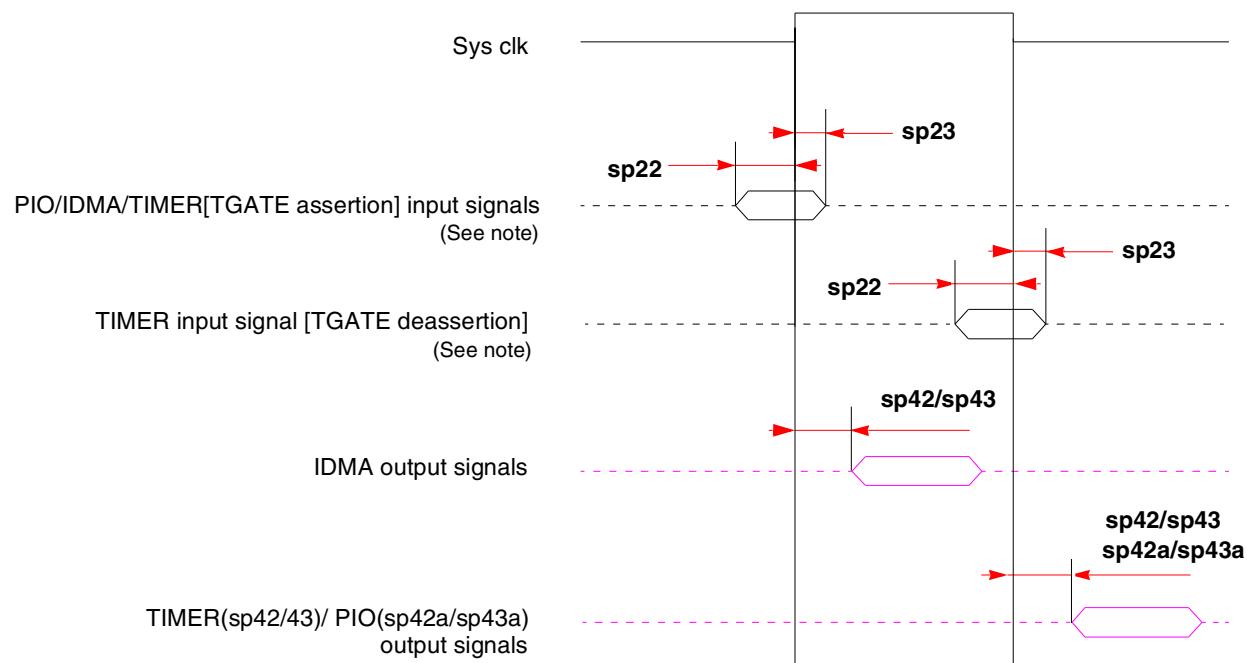
Although the specifications generally reference the rising edge of the clock, the following AC timing diagrams also apply when the falling edge is the active edge.

This figure shows the FCC internal clock.



**Figure 3. FCC Internal Clock Diagram**

This figure shows PIO and timer signals.



**Note:** TGATE is asserted on the rising edge of the clock; it is deasserted on the falling edge.

**Figure 8. PIO and Timer Signal Diagram**

## 6.2 SIU AC Characteristics

This table lists SIU input characteristics.

### NOTE: CLKIN Jitter and Duty Cycle

The CLKIN input to the SoC should not exceed  $+/- 150$  psec of jitter (peak-to-peak). This represents total input jitter—the combination of short term (peak-to-peak) and long term (cumulative). The duty cycle of CLKIN should not exceed the ratio of 40:60.

### NOTE: Spread Spectrum Clocking

Spread spectrum clocking is allowed with 1% input frequency down-spread at maximum 60 KHz modulation rate regardless of input frequency.

### NOTE: PCI AC Timing

The SoC meets the timing requirements of *PCI Specification Revision 2.2*. See [Section 7, “Clock Configuration Modes,”](#) and “Note: Tval (Output Hold)” to determine if a specific clock configuration is compliant.

## 7 Clock Configuration Modes

As shown in this table, the clocking mode is set according to two sources:

- PCI\_CFG[0]—An input signal. Also defined as “PCI\_HOST\_EN.” See Chapter 6, “External Signals,” and Chapter 9, “PCI Bridge,” in the SoC reference manual.
- PCI\_MODCK—Bit 27 in the Hard Reset Configuration Word. See Chapter 5, “Reset,” in the SoC reference manual.

**Table 16. SoC Clocking Modes**

Pins		Clocking Mode	PCI Clock Frequency Range (MHz)	Reference
PCI_CFG[0] <sup>1</sup>	PCI_MODCK <sup>2</sup>			
0	0	PCI host	50–66	<a href="#">Table 17</a>
0	1		25–50	<a href="#">Table 18</a>
1	0	PCI agent	50–66	<a href="#">Table 19</a>
1	1		25–50	<a href="#">Table 20</a>

<sup>1</sup> PCI\_HOST\_EN

<sup>2</sup> Determines PCI clock frequency range.

Within each mode, the configuration of bus, core, PCI, and CPM frequencies is determined by seven bits during the power-on reset—three hardware configuration pins (MODCK[1–3]) and four bits from hardware configuration word[28–31] (MODCK\_H). Both the PLLs and the dividers are set according to the selected clock operation mode as described in the following sections.

### NOTE

Clock configurations change only after  $\overline{\text{PORRESET}}$  is asserted.

### NOTE: Tval (Output Hold)

The minimum  $T_{val} = 2$  ns when  $\text{PCI\_MODCK} = 1$ , and the minimum  $T_{val} = 1$  ns when  $\text{PCI\_MODCK} = 0$ . Therefore, designers should use clock configurations that fit this condition to achieve PCI-compliant AC timing.

## 7.1 PCI Host Mode

These tables show configurations for PCI host mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. Note that in PCI host mode the input clock is the bus clock.

**Table 17. Clock Configurations for PCI Host Mode (PCI\_MODCK=0)<sup>1,2</sup> (continued)**

Mode <sup>3</sup>	Bus Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		PCI Division Factor <sup>6</sup>	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]											
1011_100	80.0	106.7	2.5	200.0	266.6	4	320.0	426.6	4	50.0	66.7
1011_101	80.0	106.7	2.5	200.0	266.6	4.5	360.0	480.0	4	50.0	66.7
1101_000	100.0	133.3	2.5	250.0	333.3	3	300.0	400.0	5	50.0	66.7
1101_001	100.0	133.3	2.5	250.0	333.3	3.5	350.0	466.6	5	50.0	66.7
1101_010	100.0	133.3	2.5	250.0	333.3	4	400.0	533.3	5	50.0	66.7
1101_011	100.0	133.3	2.5	250.0	333.3	4.5	450.0	599.9	5	50.0	66.7
1101_100	100.0	133.3	2.5	250.0	333.3	5	500.0	666.6	5	50.0	66.7
1101_101	125.0	166.7	2	250.0	333.3	3	375.0	500.0	5	50.0	66.7
1101_110	125.0	166.7	2	250.0	333.3	4	500.0	666.6	5	50.0	66.7
1110_000	100.0	133.3	3	300.0	400.0	3.5	350.0	466.6	6	50.0	66.7
1110_001	100.0	133.3	3	300.0	400.0	4	400.0	533.3	6	50.0	66.7
1110_010	100.0	133.3	3	300.0	400.0	4.5	450.0	599.9	6	50.0	66.7
1110_011	100.0	133.3	3	300.0	400.0	5	500.0	666.6	6	50.0	66.7
1110_100	100.0	133.3	3	300.0	400.0	5.5	550.0	733.3	6	50.0	66.7
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

<sup>1</sup> The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

<sup>2</sup> PCI\_MODCK determines the PCI clock frequency range. See [Table 18](#) for lower range configurations.

<sup>3</sup> MODCK\_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

<sup>4</sup> CPM multiplication factor = CPM clock/bus clock

<sup>5</sup> CPU multiplication factor = Core PLL multiplication factor

<sup>6</sup> CPM\_CLK/PCI\_CLK ratio. When PCI\_MODCK = 0, the ratio of CPM\_CLK/PCI\_CLK should be calculated from SCCR[PCIDF] as follows:

$$\text{CPM\_CLK/PCI\_CLK} = (\text{PCIDF} + 1) / 2.$$

**Table 18. Clock Configurations for PCI Host Mode (PCI\_MODCK=1)<sup>1,2</sup> (continued)**

Mode <sup>3</sup>	Bus Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		PCI Division Factor <sup>6</sup>	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]											
1011_101	80.0	160.0	2.5	200.0	400.0	4.5	360.0	720.0	8	25.0	50.0
<hr/>											
1101_000	50.0	100.0	2.5	125.0	250.0	3	150.0	300.0	5	25.0	50.0
1101_001	50.0	100.0	2.5	125.0	250.0	3.5	175.0	350.0	5	25.0	50.0
1101_010	50.0	100.0	2.5	125.0	250.0	4	200.0	400.0	5	25.0	50.0
1101_011	50.0	100.0	2.5	125.0	250.0	4.5	225.0	450.0	5	25.0	50.0
1101_100	50.0	100.0	2.5	125.0	250.0	5	250.0	500.0	5	25.0	50.0
<hr/>											
1101_101	62.5	125.0	2	125.0	250.0	3	187.5	375.0	5	25.0	50.0
1101_110	62.5	125.0	2	125.0	250.0	4	250.0	500.0	5	25.0	50.0
<hr/>											
1110_000	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
1110_001	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
1110_010	50.0	100.0	3	150.0	300.0	4.5	225.0	450.0	6	25.0	50.0
1110_011	50.0	100.0	3	150.0	300.0	5	250.0	500.0	6	25.0	50.0
1110_100	50.0	100.0	3	150.0	300.0	5.5	275.0	550.0	6	25.0	50.0
<hr/>											
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

<sup>1</sup> The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

<sup>2</sup> PCI\_MODCK determines the PCI clock frequency range. See [Table 17](#) for higher range configurations.

<sup>3</sup> MODCK\_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

<sup>4</sup> CPM multiplication factor = CPM clock/bus clock

<sup>5</sup> CPU multiplication factor = Core PLL multiplication factor

**Clock Configuration Modes**

<sup>6</sup> CPM\_CLK/PCI\_CLK ratio. When PCI\_MODCK = 1, the ratio of CPM\_CLK/PCI\_CLK should be calculated from PCIDF as follows:

PCIDF = 3 > CPM\_CLK/PCI\_CLK = 4  
 PCIDF = 5 > CPM\_CLK/PCI\_CLK = 6  
 PCIDF = 7 > CPM\_CLK/PCI\_CLK = 8  
 PCIDF = 9 > CPM\_CLK/PCI\_CLK = 5  
 PCIDF = B > CPM\_CLK/PCI\_CLK = 6

## 7.2 PCI Agent Mode

These tables show configurations for PCI agent mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device. Note that in PCI agent mode the input clock is PCI clock.

**Table 19. Clock Configurations for PCI Agent Mode (PCI\_MODCK=0)<sup>1,2</sup>**

Mode <sup>3</sup>	PCI Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H - MODCK[1-3]	Default Modes (MODCK_H=0000)										
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0000_100	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0000_101	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0000_110	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0000_111	50.0	66.7	4	200.0	266.6	3	240.0	320.0	2.5	80.0	106.7
Full Configuration Modes											
0001_001	60.0	66.7	2	120.0	133.3	5	150.0	166.7	4	30.0	33.3
0001_010	50.0	66.7	2	100.0	133.3	6	150.0	200.0	4	25.0	33.3
0001_011	50.0	66.7	2	100.0	133.3	7	175.0	233.3	4	25.0	33.3
0001_100	50.0	66.7	2	100.0	133.3	8	200.0	266.6	4	25.0	33.3
0010_001	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0010_010	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0010_011	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
0010_100	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0

**Table 19. Clock Configurations for PCI Agent Mode (PCI\_MODCK=0)<sup>1,2</sup> (continued)**

Mode <sup>3</sup>	PCI Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)		
	Low	High		Low	High		Low	High		Low	High	
MODCK_H- MODCK[1-3]												
0011_000					Reserved							
0011_001					Reserved							
0011_010					Reserved							
0011_011					Reserved							
0011_100					Reserved							
0100_000					Reserved							
0100_001	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7	
0100_010	50.0	66.7	3	150.0	200.0	3.5	175.0	200.0	3	50.0	66.7	
0100_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7	
0100_100	50.0	66.7	3	150.0	200.0	4.5	225.0	300.0	3	50.0	66.7	
0101_000	50.0	66.7	5	250.0	333.3	2.5	250.0	333.3	2.5	100.0	133.3	
0101_001	50.0	66.7	5	250.0	333.3	3	300.0	400.0	2.5	100.0	133.3	
0101_010	50.0	66.7	5	250.0	333.3	3.5	350.0	466.6	2.5	100.0	133.3	
0101_011	50.0	66.7	5	250.0	333.3	4	400.0	533.3	2.5	100.0	133.3	
0101_100	50.0	66.7	5	250.0	333.3	4.5	450.0	599.9	2.5	100.0	133.3	
0101_101	50.0	66.7	5	250.0	333.3	5	500.0	666.6	2.5	100.0	133.3	
0101_110	50.0	66.7	5	250.0	333.3	5.5	550.0	733.3	2.5	100.0	133.3	
0110_000					Reserved							
0110_001	50.0	66.7	4	200.0	266.6	3	200.0	266.6	3	66.7	88.9	
0110_010	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9	
0110_011	50.0	66.7	4	200.0	266.6	4	266.7	355.5	3	66.7	88.9	
0110_100	50.0	66.7	4	200.0	266.6	4.5	300.0	400.0	3	66.7	88.9	
0111_000	50.0	66.7	3	150.0	200.0	2	150.0	200.0	2	75.0	100.0	
0111_001	50.0	66.7	3	150.0	200.0	2.5	187.5	250.0	2	75.0	100.0	
0111_010	50.0	66.7	3	150.0	200.0	3	225.0	300.0	2	75.0	100.0	
0111_011	50.0	66.7	3	150.0	200.0	3.5	262.5	350.0	2	75.0	100.0	

**Table 19. Clock Configurations for PCI Agent Mode (PCI\_MODCK=0)<sup>1,2</sup> (continued)**

Mode <sup>3</sup>	PCI Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]											
1100_101	50.0	66.7	6	300.0	400.0	4	400.0	533.3	3	100.0	133.3
1100_110	50.0	66.7	6	300.0	400.0	4.5	450.0	599.9	3	100.0	133.3
1100_111	50.0	66.7	6	300.0	400.0	5	500.0	666.6	3	100.0	133.3
1101_000	50.0	66.7	6	300.0	400.0	5.5	550.0	733.3	3	100.0	133.3
1101_001	50.0	66.7	6	300.0	400.0	3.5	420.0	559.9	2.5	120.0	160.0
1101_010	50.0	66.7	6	300.0	400.0	4	480.0	639.9	2.5	120.0	160.0
1101_011	50.0	66.7	6	300.0	400.0	4.5	540.0	719.9	2.5	120.0	160.0
1101_100	50.0	66.7	6	300.0	400.0	5	600.0	799.9	2.5	120.0	160.0
1110_000	50.0	66.7	5	250.0	333.3	2.5	312.5	416.6	2	125.0	166.7
1110_001	50.0	66.7	5	250.0	333.3	3	375.0	500.0	2	125.0	166.7
1110_010	50.0	66.7	5	250.0	333.3	3.5	437.5	583.3	2	125.0	166.7
1110_011	50.0	66.7	5	250.0	333.3	4	500.0	666.6	2	125.0	166.7
1110_100	50.0	66.7	5	250.0	333.3	4	333.3	444.4	3	83.3	111.1
1110_101	50.0	66.7	5	250.0	333.3	4.5	375.0	500.0	3	83.3	111.1
1110_110	50.0	66.7	5	250.0	333.3	5	416.7	555.5	3	83.3	111.1
1110_111	50.0	66.7	5	250.0	333.3	5.5	458.3	611.1	3	83.3	111.1
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

<sup>1</sup> The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

<sup>2</sup> PCI\_MODCK determines the PCI clock frequency range. See [Table 20](#) for lower range configurations.

<sup>3</sup> MODCK\_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

<sup>4</sup> CPM multiplication factor = CPM clock/bus clock

<sup>5</sup> CPU multiplication factor = Core PLL multiplication factor

## Clock Configuration Modes

**Table 20. Clock Configurations for PCI Agent Mode (PCI\_MODCK=1)<sup>1,2</sup> (continued)**

Mode <sup>3</sup>	PCI Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H-MODCK[1-3]											
1001_010	Reserved										
1001_011	25.0	50.0	8	200.0	400.0	4	200.0	400.0	4	50.0	100.0
1001_100	25.0	50.0	8	200.0	400.0	4.5	225.0	450.0	4	50.0	100.0
1010_000	Reserved										
1010_001	25.0	50.0	8	200.0	400.0	3	200.0	400.0	3	66.7	133.3
1010_010	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
1010_011	25.0	50.0	8	200.0	400.0	4	266.7	533.3	3	66.7	133.3
1010_100	25.0	50.0	8	200.0	400.0	4.5	300.0	600.0	3	66.7	133.3
1011_000	Reserved										
1011_001	25.0	50.0	8	200.0	400.0	2.5	200.0	400.0	2.5	80.0	160.0
1011_010	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
1011_011	25.0	50.0	8	200.0	400.0	3.5	280.0	560.0	2.5	80.0	160.0
1011_100	25.0	50.0	8	200.0	400.0	4	320.0	640.0	2.5	80.0	160.0
1011_101	25.0	50.0	8	200.0	400.0	2.5	250.0	500.0	2	100.0	200.0
1011_110	25.0	50.0	8	200.0	400.0	3	300.0	600.0	2	100.0	200.0
1011_111	25.0	50.0	8	200.0	400.0	3.5	350.0	700.0	2	100.0	200.0
1100_101	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
1100_110	25.0	50.0	6	150.0	300.0	4.5	225.0	450.0	3	50.0	100.0
1100_111	25.0	50.0	6	150.0	300.0	5	250.0	500.0	3	50.0	100.0
1101_000	25.0	50.0	6	150.0	300.0	5.5	275.0	550.0	3	50.0	100.0
1101_001	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
1101_010	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
1101_011	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
1101_100	25.0	50.0	6	150.0	300.0	5	300.0	600.0	2.5	60.0	120.0

**Table 20. Clock Configurations for PCI Agent Mode (PCI\_MODCK=1)<sup>1,2</sup> (continued)**

Mode <sup>3</sup>	PCI Clock (MHz)		CPM Multiplication Factor <sup>4</sup>	CPM Clock (MHz)		CPU Multiplication Factor <sup>5</sup>	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
MODCK_H- MODCK[1-3]											
1110_000	25.0	50.0	5	125.0	250.0	2.5	156.3	312.5	2	62.5	125.0
1110_001	25.0	50.0	5	125.0	250.0	3	187.5	375.0	2	62.5	125.0
1110_010	28.6	50.0	5	142.9	250.0	3.5	250.0	437.5	2	71.4	125.0
1110_011	25.0	50.0	5	125.0	250.0	4	250.0	500.0	2	62.5	125.0
1110_100	25.0	50.0	5	125.0	250.0	4	166.7	333.3	3	41.7	83.3
1110_101	25.0	50.0	5	125.0	250.0	4.5	187.5	375.0	3	41.7	83.3
1110_110	25.0	50.0	5	125.0	250.0	5	208.3	416.7	3	41.7	83.3
1110_111	25.0	50.0	5	125.0	250.0	5.5	229.2	458.3	3	41.7	83.3
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

<sup>1</sup> The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

<sup>2</sup> PCI\_MODCK determines the PCI clock frequency range. See [Table 19](#) for higher range configurations.

<sup>3</sup> MODCK\_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

<sup>4</sup> CPM multiplication factor = CPM clock/bus clock

<sup>5</sup> CPU multiplication factor = Core PLL multiplication factor

## 8 Pinout

This figure and table show the pin assignments and pinout for the 516 PBGA package.

**Table 21. Pinout (continued)**

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PCI_IRDY		AF15
PCI_STOP		AE15
PCI_DEVSEL		AE14
PCI_IDSEL		AC17
PCI_PERR		AD14
PCI_SERR		AD13
PCI_REQ0		AE20
PCI_REQ1/CPCI_HS_ES		AF14
PCI_GNT0		AD20
PCI_GNT1/CPCI_HS_LED		AE13
PCI_GNT2/CPCI_HS_ENUM		AF21
PCI_RST		AF22
PCI_INTA		AE21
PCI_REQ2		AB14
DLLOUT		AC22
PCI_AD0		AF7
PCI_AD1		AE10
PCI_AD2		AB10
PCI_AD3		AD10
PCI_AD4		AE9
PCI_AD5		AF8
PCI_AD6		AC10
PCI_AD7		AE11
PCI_AD8		AB11
PCI_AD9		AF10
PCI_AD10		AF9
PCI_AD11		AB12
PCI_AD12		AC12
PCI_AD13		AD12
PCI_AD14		AF11
PCI_AD15		AB13

**Table 21. Pinout (continued)**

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
MODCK1/RSRV/TC0/BNKSEL0		A20
MODCK2/CSE0/TC1/BNKSEL1		C20
MODCK3/CSE1/TC2/BNKSEL2		A21
CLKIN1		D21
PA8/SMRXD2		AF25 <sup>3</sup>
PA9/SMTXD2		AA22 <sup>3</sup>
PA10/MSNUM5	FCC1_UT_RXD0	AB23 <sup>3</sup>
PA11/MSNUM4	FCC1_UT_RXD1	AD26 <sup>3</sup>
PA12/MSNUM3	FCC1_UT_RXD2	AD25 <sup>3</sup>
PA13/MSNUM2	FCC1_UT_RXD3	AA24 <sup>3</sup>
PA14/FCC1_MII_HDLC_RXD3	FCC1_UT_RXD4	W22 <sup>3</sup>
PA15/FCC1_MII_HDLC_RXD2	FCC1_UT_RXD5	Y24 <sup>3</sup>
PA16/FCC1_MII_HDLC_RXD1	FCC1_UT_RXD6	T22 <sup>3</sup>
PA17/FCC1_MII_HDLC_RXD0/ FCC1_MII_TRAN_RXD/FCC1_RMII_RX D0	FCC1_UT_RXD7	W26 <sup>3</sup>
PA18/FCC1_MII_HDLC_TXD0/FCC1_MII _TRAN_TXD/ FCC1_RMII_TXD0	FCC1_UT_TXD7	V26 <sup>3</sup>
PA19/FCC1_MII_HDLC_TXD1/FCC1_RM II_TXD1	FCC1_UT_TXD6	R23 <sup>3</sup>
PA20/FCC1_MII_HDLC_TXD2	FCC1_UT_TXD5	P25 <sup>3</sup>
PA21/FCC1_MII_HDLC_TXD3	FCC1_UT_TXD4	N22 <sup>3</sup>
PA22	FCC1_UT_TXD3	N26 <sup>3</sup>
PA23	FCC1_UT_TXD2	N23 <sup>3</sup>
PA24/MSNUM1	FCC1_UT_TXD1	H26 <sup>3</sup>
PA25/MSNUM0	FCC1_UT_TXD0	G25 <sup>3</sup>
PA26/FCC1_MII_RMIIRX_ER	FCC1_UT_RXCLAV	L22 <sup>3</sup>
PA27/FCC1_MII_RX_DV/FCC1_RMII_CR S_DV	FCC1_UT_RXSOC	G24 <sup>3</sup>
PA28/FCC1_MII_RMII_TX_EN	FCC1_UT_RXENB	G23 <sup>3</sup>
PA29/FCC1_MII_TX_ER	FCC1_UT_TXSOC	B26 <sup>3</sup>
PA30/FCC1_MII_CRS/FCC1_RTS	FCC1_UT_TXCLAV	A25 <sup>3</sup>

## 10 Ordering Information

This figure provides an example of the Freescale part numbering nomenclature for the SoC. In addition to the processor frequency, the part numbering scheme also consists of a part modifier that indicates any enhancement(s) in the part from the original production design. Each part number also contains a revision code that refers to the die mask revision number and is specified in the part numbering scheme for identification purposes only. For more information, contact your local Freescale sales office.

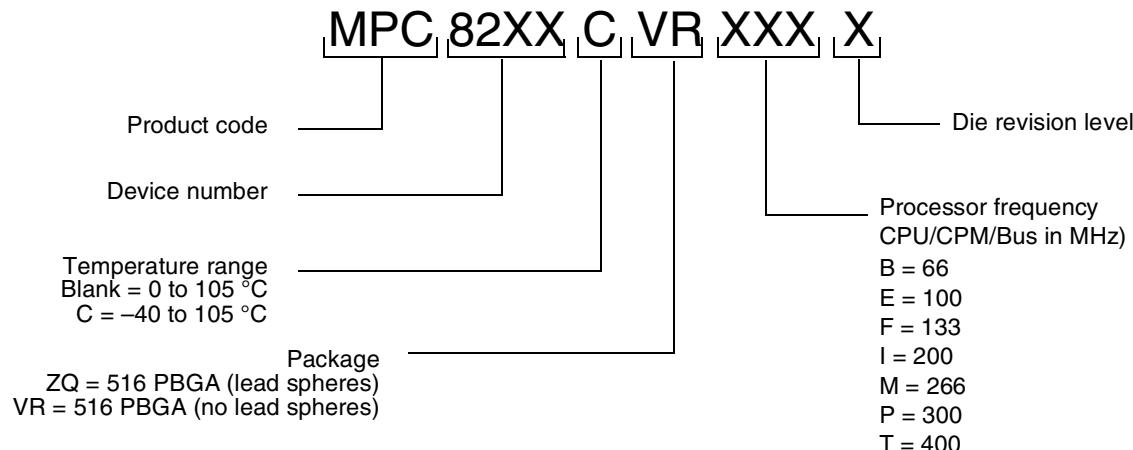


Figure 15. Freescale Part Number Key

## 11 Document Revision History

This table summarizes changes to this document.

Table 23. Document Revision History

Revision	Date	Substantive Changes
3	09/2011	In <a href="#">Figure 15</a> , “Freescale Part Number Key,” added speed decoding information below processor frequency information.
2	12/2008	<ul style="list-style-type: none"> <li>Modified <a href="#">Figure 5</a>, “SCC/SMC/SPI/I2C External Clock Diagram,” and added second section of figure notes.</li> <li>In <a href="#">Table 12</a>, modified “Data bus in pipeline mode” row and showed 66 MHz as “N/A.”</li> <li>In <a href="#">Section 10, “Ordering Information,”</a> added “F = 133” to CPU/CPM/Bus Frequency.</li> <li>Added footnote concerning CPM_CLK/PCI_CLK ratio to column “PCI Division Factor” in <a href="#">Table 17</a>, “Clock Configurations for PCI Host Mode (PCI_MODCK=0),” and <a href="#">Table 18</a>, “Clock Configurations for PCI Host Mode (PCI_MODCK=1).”</li> <li>Removed overbar from DLL_ENABLE in <a href="#">Table 21</a>, “Pinout.”</li> </ul>
1.5	12/2006	<ul style="list-style-type: none"> <li><a href="#">Section 6, “AC Electrical Characteristics,”</a> removed deratings statement and clarified AC timing descriptions.</li> </ul>
1.4	05/2006	<ul style="list-style-type: none"> <li>Added row for 133 MHz configurations to <a href="#">Table 8</a>.</li> </ul>
1.3	02/2006	<ul style="list-style-type: none"> <li>Inserted <a href="#">Section 6.3, “JTAG Timings.”</a></li> </ul>

**Table 23. Document Revision History (continued)**

Revision	Date	Substantive Changes
1.2	09/2005	<ul style="list-style-type: none"> <li>Added 133-MHz to the list of frequencies in the opening sentence of <a href="#">Section 6, “AC Electrical Characteristics”</a>.</li> <li>Added 133 MHz columns to <a href="#">Table 9</a>, <a href="#">Table 11</a>, <a href="#">Table 12</a>, and <a href="#">Table 13</a>.</li> <li>Added footnote 2 to <a href="#">Table 13</a>.</li> <li>Added the conditions note directly above <a href="#">Table 12</a>.</li> </ul>
1.1	01/2005	<ul style="list-style-type: none"> <li>Modification for correct display of assertion level (“overbar”) for some signals</li> </ul>
1.0	12/2004	<ul style="list-style-type: none"> <li>Section 1.1: Added 8:1 ratio to Internal CPM/bus clock multiplier values</li> <li>Section 2: removed voltage tracking note</li> <li><a href="#">Table 3</a>: Note 2 updated regarding VDD/VCCSYN relationship to VDDH during power-on reset</li> <li><a href="#">Table 4</a>: Updated VDD and VCCSYN to 1.425 V - 1.575 V</li> <li><a href="#">Table 8</a>: Note 2 updated to reflect VIH=2.5 for TCK, TRST, PORESET; request for external pull-up removed.</li> <li>Section 4.6: Updated description of layout practices</li> <li><a href="#">Table 8</a>: Note 3 added regarding IIC compatibility</li> <li><a href="#">Table 8</a>: Updated nominal and maximum power dissipation values</li> <li><a href="#">Table 9</a>: updated PCI impedance to <math>27\Omega</math>, updated 60x and MEMC values and added note to reflect configurable impedance</li> <li>Section 6: Added sentence providing derating factor</li> <li>Section 6.1: added Note: Rise/Fall Time on CPM Input Pins</li> <li><a href="#">Table 9</a>: updated values for following specs: sp36b, sp37a, sp38a, sp39a, sp38b, sp40, sp41, sp42, sp43, sp42a</li> <li><a href="#">Table 11</a>: updated values for following specs: sp16a, sp16b, sp18a, sp18b, sp20, sp21, sp22</li> <li>Section 6.2: added spread spectrum clocking note</li> <li>Section 6.2: added CLKIN jitter note</li> <li><a href="#">Table 12</a>: combined specs sp11 and sp11a</li> <li><a href="#">Table 13</a>: sp30 Data Bus minimum delay values changed to 0.8</li> <li>Section 7: unit of ns added to Tval notes</li> <li>Section 7: Updated all notes to reflect updated CPU Fmin of 150 MHz commercial temp devices, 175 MHz extended temp; CPM Fmin of 120 MHz.</li> <li><a href="#">Section 7, “Clock Configuration Modes”</a>: Updated all table footnotes reflect updated CPU Fmin of 150 MHz commercial temp devices, 175 MHz extended temp; CPM Fmin of 120 MHz.</li> <li><a href="#">Table 21</a>: correct superscript of footnote number after pin AD22</li> <li><a href="#">Table 21</a>: remove DONE3 from PC12</li> <li><a href="#">Table 21</a>: signals referring to TDMs C2 and D2 removed</li> </ul>